

### UltraTEC™ UT Series Thermoelectric Cooler

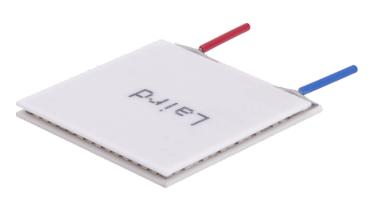
The UT8-12-F2-2525-TA-EP-W6 is a high heat flux density thermoelectric cooler. The thermoelectric module is assembled with a large number of semiconducting thermoelectric couples to achieve a higher heat pumping capacity than standard single stage thermoelectric coolers. It has a maximum Qc of 63.8 Watts when  $\Delta T=0$  and a maximum  $\Delta T$  of 68.9 °C at Qc = 0.

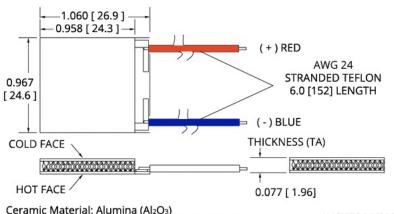
#### **Features**

- High heat pump density
- Precise temperature control
- Reliable solid-state operation
- No sound or vibration
- DC operationRoHS-compliant

#### **Applications**

- Thermoelectric Coolers and Assemblies for Medical Applications
- Thermoelectric Coolers for Handheld Cosmetic Lasers
- Industrial Laser Cooling
- Peltier Cooling for Digital Light Processors



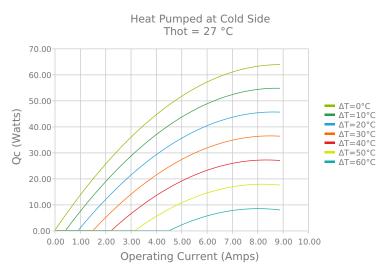


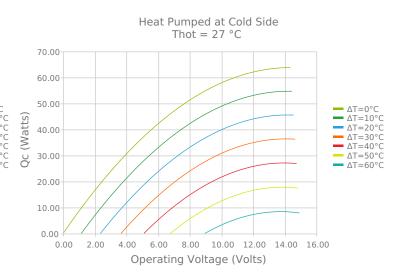
Ceramic Material: Alumina (Al<sub>2</sub>O<sub>3</sub>) Solder Construction: 138°C, Bismuth Tin (BiSn)

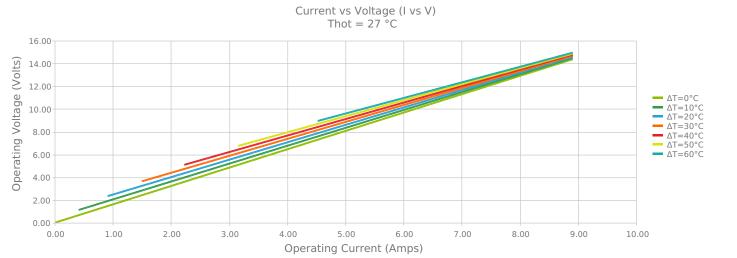
INCHES [ MM ]

Note: Allow 0.020 in [0.5 mm] around perimeter of the thermoelectric cooler and lead wire attachment to accommodate sealant

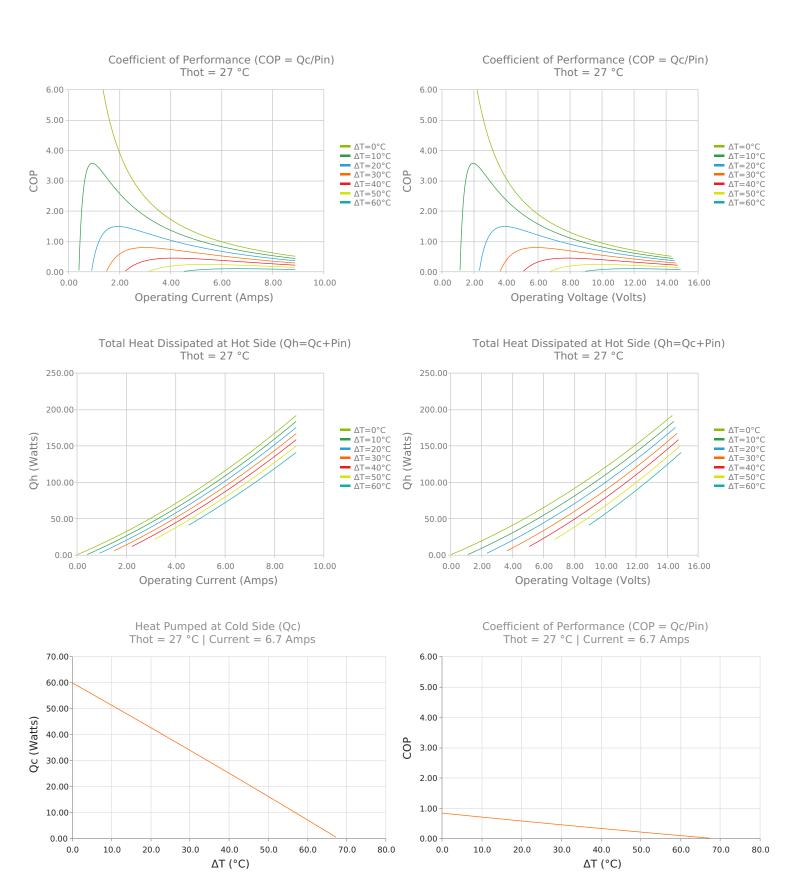
### **ELECTRICAL AND THERMAL PERFORMANCE**













## **SPECIFICATIONS\***

**Hot Side Temperature** 

 $Qcmax (\Delta T = 0)$ 

 $\Delta T max (Qc = 0)$ 

Imax (I @ \Darmax)

Vmax (V @ \Darmax)

**Module Resistance** 

**Max Operating Temperature** 

Weight

27.0 °C	35.0 °C	50.0 °C
63.8 Watts	65.8 Watts	69.2 Watts
68.9°C	71.8°C	77.0°C
7.9 Amps	7.8 Amps	7.8 Amps
13.6 Volts	14.2 Volts	15.1 Volts
1.61 Ohms	1.68 Ohms	1.81 Ohms
80 °C		
7.0 gram(s)		

## **FINISHING OPTIONS**

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
TA	1.956 ±0.025 mm 0.077 ± 0.001 in	0.025 mm / 0.025 mm 0.001 in / 0.001 in	Lapped	Lapped	152.4 mm 6.00 in

### **SEALING OPTIONS**

Suffix	Sealant	Color	<b>Temp Range</b>	Description
EP	Ероху	Black	-55 to 150°C	Low density syntactic foam epoxy encapsulant

# **NOTES**

- 1. Max operating temperature: 80°C
- 2. Do not exceed Imax or Vmax when operating module
- 3. Reference assembly guidelines for recommended installation

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<sup>\*</sup> Specifications reflect thermoelectric coefficients updated March 2020